

Upcoming: October 14–18, Radioactive Waste, Storage, Transportation, Recycling: Environment and Human Impact, R-MRS, E-MRS; December 1–5, MRS Fall Meeting, MRS.

To list an event in the Calendar, contact J. Melksin, Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 412-779-3004 ext. 522; fax 412-779-8313.

MRS, A-MRS, C-MRS, E-MRS, MRS-I, MRS-J, MRS-K, MRS-R, MRS-T, M-MRS, or IU/MRS at the end of an entry indicates sponsorship or co-sponsorship of an event by the International Union of Materials Research Societies or one of its adhering bodies. "Endorsed" identifies events endorsed by MRS.

▼ identifies a new or revised entry this month.

See the July 1997 MRS BULLETIN for September 1997 Calendar entries.

OCTOBER 1997

1–2 Microelectronic Manufacturing, *Austin, TX*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; <http://www.spie.org>.

1–2 OEM Electronics Conf., *Boston, MA*. D. Waltersdorf, Exposition Excellence Corp., 112 Main St., Norwalk, CT 06851; 203-847-9599; fax 203-854-9438.

1–2 ▼ Understanding and Utilizing Colossal Magnetoresistance Materials, *London, UK*. The Royal Society, 6 Carlton House Terrace, London SW1Y 5AG, UK; 44-171-839-5561; fax 44-171-451-2693; <http://www.royalsoc.ac.uk/rs>.

5–8 16th North American Conf. on Molecular Beam Epitaxy, *Ann Arbor, MI*. P. Bhattacharya, Conf. Chair, Univ. of Michigan, Dept. of EE&CS, 1301 Beal Ave., Ann Arbor, MI 48109; 313-763-6678; e-mail pkb@eecs.umich.edu.

5–8 Julian Szekely Memorial Symposium on Materials Processing, *Cambridge, MA*. TMS Customer Service Dept., 420 Commonwealth Dr., Warrendale, PA 15086; 412-766-9000; fax 412-766-3770; e-mail csc@tms.org.

6–8 12th Annual Technical Conf. of the American Society for Composites, *Dearborn, MI*. A. Duffer, Conf. Secretary, Mechanical Engineering Dept., Wayne State Univ., Detroit, MI 48202; 313-577-3877; fax 313-577-8789; e-mail gnewaz@eng.wayne.edu.

6–9 IEEE Intl. Silicon-on-Insulator Conf., *Yosemite, CA*. S. Grawet, All About Meetings, Inc.; 310-316-5153; fax 310-316-0713; e-mail 70541.1225@compuserve.com.

6–9 Intl. Rubber Conf., *Kuala Lumpur, Malaysia*. Secretary IRC'97 Malaysia, Rubber Research Inst. of Malaysia, P.O. Box 10150, 50908 Kuala Lumpur, Malaysia; 603-456-4516; fax 603-457-3512; e-mail drong@pop.jaring.my.

6–10 8th Workshop on RF Superconductivity, *Padova, Italy*. V. Palmieri, Chairman, 8th Workshop on RF Superconductivity, INFN LNL Via Romea 4, Legnaro (Padua), Italy; fax 39-49-641925; e-mail abano@lnl.infn.it.

6–10 11th Intl. Conf. on Photopolymers and Intl. Conf. on Polyimides and Other Low K Dielectrics, *McAfee, NJ*. M.M. Khojasteh, IBM Corp., Microelectronics Div., 8/300-40E, 1580 Rt. 52, Hopewell Junction, NY 12533; 914-894-5458; fax 914-892-6256; e-mail mkhjoasteh@vnet.ibm.com.

8 Intl. Symposium on Solar Chemistry, *Villigen, Switzerland*. T. Daum, Secretariat, Solar Chemistry Symposium, Paul Scherrer Inst., CH-5232 Villigen PSI, Switzerland; 41-56-3102896; fax 41-56-3102199; e-mail cdaum@psi.ch.

10–11 ▼ Ohio Section/APS Fall 1997 Meeting, *Oxford, OH*. P. Scholten, Dept. of Physics, Miami Univ., Oxford, OH 45056; 513-529-5636; fax 513-529-5629; e-mail scholtpd@muohio.edu; <http://www.phy.ohio.edu/~osaps>.

11–17 OSA Annual Meeting, *Long Beach, CA*. Meetings Dept., Optical Society of America, 2010 Massachusetts Ave. NW, Washington, DC 20036-1023; 202-223-0920; fax 202-416-6100.

12–15 49th Pacific Coast Regional Meeting and American Ceramic Society Basic Science Division Meeting, *San Francisco, CA*. Customer Service Dept., American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrv@acers.org.

12–16 30th Intl. Symposium on Microelectronics, *Philadelphia, PA*. ISHM'97/Intl. Microelectronics and Packaging Society, 1850 Centennial Park Dr., Ste. 105, Reston, VA 20191-1517; 703-758-1060; 703-758-1066; e-mail IMAPS@aol.com.

13–15 5th Intl. Symposium on Brittle Matrix Composites, *Warsaw, Poland*. A.M. Brandt, IFTR, Swietokrzyska 21, 00-049 Warsaw, Poland; fax 48-22-269815; e-mail abrاندt@ippt.gov.pl.

13–17 ▼ NACE Intl. Southeast Region Annual Conf., *Birmingham, AL*. NACE Intl., P.O. Box 218340, Houston, TX 77218-8340; 713-492-0535; fax 713-492-8254; <http://www.nace.org>.

14–16 ACeRS Electronics Div. Meeting with the Intl. Microelectronics and Packaging Society, *Philadelphia, PA*. Customer Service Dept., American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrv@acers.org; <http://www.acers.org>.

14–17 Intelligent Systems and Advanced Manufacturing, *Pittsburgh, PA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; <http://www.spie.org>.

14–18 Radioactive Waste, Storage, Transportation, Recycling: Environment and Human Impact, *St. Petersburg, Russia*. Shpalernaja str. 49, 193015 St. Petersburg, Russia; 7-812-274-3796; fax 7-812-274-1707; e-mail kkv@prometey2.spb.su. **R-MRS, E-MRS.**

15–16 Quality Issues Conf., *Pittsburgh, PA*. H.G. Nowicki, Professional Analytical and Consulting Services, Inc., 409 Meade Dr., Coraopolis, PA 15108; 412-457-6576; fax 412-457-1214; e-mail hnpcs@aol.com; <http://members.aol.com/hnpcs/pacs/htm>.

19–22 ▼ NACE Intl. Northeast Region Annual Conf., *Secaucus, NJ*. NACE Intl., P.O. Box 218340, Houston, TX 77218-8340; 713-492-0535; fax 713-492-8254; <http://www.nace.org>.

20–22 ▼ 9th Intl. Business Conf.—World Hot Isostatic Pressing Markets 1997, *Columbus, OH*. C. Jones, Gorham Advanced Materials, Inc., P.O. Box 250, Gorham, ME 04038-0250; 207-892-5445; fax 207-892-2210; e-mail gorham@goradv.com.

20–24 1997 Fall Conf. and Quality Testing Show, *Pittsburgh, PA*. American Society for Nondestructive Testing, Inc., 1711 Arlington Lane, P.O. Box 28518, Columbus, OH 43228-0518; 800-222-2768 or 614-274-6003; fax 614-274-6899; <http://www.asnt.org>.

20–24 15th Intl. Conf. on Magnet Technology, *Beijing, China*. L. Lin, MT-15 Program Committee, Applied Superconductivity Div., Inst. of Electrical Engineering, Chinese Academy of Sciences, P.O. Box 2703, Beijing 100080, P.R. China; 86-10-6256-1492; fax 86-10-6256-0904; e-mail asd@piano.iese.ac.cn.

20–24 44th American Vacuum Society National Symposium, *Santa Jose, CA*. A. Mulligan, American Vacuum Society, 120 Wall St., 32nd Floor, New York, NY 10005; 212-248-0200; fax 212-248-0245; e-mail angela@vacuum.org; <http://www.vacuum.org>.

21–23 1997 U.S. Workshop on Physics and Chemistry of II-VI Materials, *Santa Barbara, CA*. M. Goldfarb, 1997 II-VI Workshop, Palisades Inst. for Research Services, Inc., 201 Varick St., Ste. 1006, New York, NY 10014; 703-413-3891; fax 703-413-1315; e-mail mgoldfar@washington.palisades.org.

21–23 Medical Equipment Design and Technology Conf., *Amsterdam, The Netherlands*. Canon Communications, Inc., 3340 Ocean Park Blvd., Ste. 1000, Santa Monica, CA 90405-3216; 310-392-5509; fax 310-392-1557; <http://www.cancom.com>.

23–24 ▼ Polyethylene—New Technology, New Markets, *London, UK*. C. Pearcey, Conf. Dept., The Inst. of Materials, 1 Carlton House Terrace, London SW1Y 5DB, UK; 44-171-839-4071; 44-171-823-1638.

24–31 American Ceramic Society Glass and Optical Materials Division Joint Meeting with the Optical Society of America, *Williamsburg, VA*. Customer Service Dept., American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrv@acers.org.

27–30 10th Intl. Symposium on Superconductivity, *Gifu, Japan*. ISS'97 Secretariat, ISTE, Eishin Kaihatsu Bldg. 6F, 34-3 Shimbashi 5-chome, Minato-ku, Tokyo 105, Japan; 81-3-3431-4002; fax 81-3-3431-4044.

27–31 2nd Intl. Conf. on Nitride Semiconductors, *Tokushima, Japan*. S. Yoshida, ICNS'97, Materials Science Div., Electrotechnical Lab., 1-1-4 Umezono, Tsukuba, Ibaraki 305, Japan; 81-298-54-5222; fax 81-298-58-5434; e-mail syoshida@etl.go.jp; <http://www-icns.ee.tokushima-u.ac.jp>.

27–31 23rd Intl. Symposium for Testing and Failure Analysis, *Santa Clara, CA*. ASM Intl., Member Services Center, Materials Park, OH 44073-0002; 216-338-5151; fax 216-338-4634; e-mail memserv@po.asm-intl.org.

27–31 Joint Magneto-Optical Recording Intl. Symposium and Intl. Symposium on Optical Memory, *Yamagata, Japan*. Secretariat for the Joint MORIS/ISOM '97, c/o Business Center for Academic Societies Japan, 5-16-9 Honkomagome, Bunkyo-ku, Tokyo 113, Japan; 81-3-5814-5800; fax 81-3-5814-5823.

28–30 1st Intl. Symposium on Nuclear and Related Techniques in Agriculture, Industry, Health, and Environment and 3rd Workshop on Nuclear Physics, *Havana, Cuba*. L. Desdín, Ctr. de Estudios Aplicados al Desarrollo Nuclear, P.O. Box 6122, Habana, Cuba; 537-221518; fax 537-221518; e-mail root@ceaden.cigb.edu.cu.

28–30 ▼ 2nd Intl. Conf. on Composite Materials for Offshore Operations, *Houston, TX*. CMOO-2 Secretary, Composites Engineering and Applications Ctr., Univ. of Houston, Houston, TX 77204-0900; 713-743-5053; fax 713-543-5063; e-mail cmoo2@uh.edu; <http://www.egr.uh.edu/CEAC/cmoo2.html>.

29–1 Annual Convention of the Composites Fabricators Association and the Society for the Advancement of Material and Process Engineering, *Orlando, FL*. M. Henriksen, COMPOSITES 97, Composites Fabricators Association, 8201 Greensboro Dr., Ste. 300, McLean, VA 22102; 703-610-9025; fax 703-610-9005; e-mail cfa.info@cfa.hq.org.

NOVEMBER 1997

2–7 ▼ NACE Intl. Western Region Annual Conf., *Palm Springs, CA*. NACE Intl., P.O. Box 218340, Houston, TX 77218-8340; 713-492-0535; fax 713-492-8254; <http://www.nace.org>.

3–4 ▼ The Wilson Forum—East on Existing and Potential Applications of Composite Materials in the Infrastructure, *Boca Raton, FL*. N. Anders, Wilson Composite Group, Inc., 6611 Folsom-Auburn Rd., Ste. C, Folsom, CA 95630-2100; 961-989-4812; fax 916-989-1714; e-mail norma_anders@wcgi.us@wcgi.com.

3-5 ▼ The Third International Conference on the Science and Technology of Display Phosphors, *Huntington Beach, CA*. William Klein, Palisades Institute for Research Services, Suite 1006, 201 Varick St., New York, NY 10014; 212-620-3377; fax 212-620-3379.

4-6 ▼ Conf. on World Powder Metallurgy Markets 1997, *Atlanta, GA*. C. Jones, Gorham Advanced Materials, Inc., P.O. Box 250, Gorham, ME 04038-0250; 207-892-5445; fax 207-892-2210; e-mail gorham@goradv.com.

4-8 Unified Intl. Technical Conf. on Refractories, *New Orleans, LA*. Jerry E. Elliott, The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5866; fax 614-899-6109; e-mail elliot@acers.org.

9-11 Workshop on Tribology Issues and Opportunities in Micro Electro Mechanical Systems, *Columbus, OH*. B. Bhushan, Dept. of Mechanical Engineering, Ohio State Univ., Columbus, OH 43210-1107; 614-292-0651; fax 614-292-0325; e-mail bhushan.2@osu.edu.

10-12 ▼ NACE Intl. Northern Area Annual Conf., *Toronto, Ontario, Canada*. NACE Intl., P.O. Box 218340, Houston, TX 77218-8340; 713-492-0535; fax 713-492-8254; <http://www.nace.org>.

10-12 ▼ World Photovoltaic Power Conf., *San Diego, CA*. C. Jones, Gorham Advanced Materials, Inc., P.O. Box 250, Gorham, ME 04038-0250; 207-892-5445; fax 207-892-2210; e-mail gorham@goradv.com.

11-13 ▼ ACeRS Whitewares and Materials and Equipment Divisions Joint Meeting with Southwest Section, *San Antonio, TX*. American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrvc@acers.org; <http://www.acers.org>.

12-14 ▼ Market and Business Outlook for Gallium Arsenide and Other Compound Semiconductors, *San Diego, CA*. C. Jones, Gorham/Intertech Consulting, P.O. Box 250, Gorham, ME 04038-0250; 207-892-5445; fax 207-892-2210; e-mail gorham@goradv.com.

16-19 1997 Intl. Conf. on Tungsten, Refractory Metals, and Alloys, *Orlando, FL*. Metal Powder Industries Federation, 105 College Rd. East, Princeton, NJ 08540; 609-452-7700; fax 609-987-8523; e-mail info@mpif.org.

16-21 1997 Congress of the American Society of Mechanical Engineers, *Dallas, TX*. G.J. Wiens, Program Chair, Dept. of Mechanical Engineering, 237 MEB, Univ. of Florida, Gainesville, FL 32611-6300; 904-392-0806; fax 904-392-1071; e-mail gwiens@cimar.me.ufl.edu.

16-21 AIChE Annual Meeting, *Los Angeles, CA*. American Inst. of Chemical Engineers, 345 E. 47th St., New York, NY 10017-2395; 1-800-242-4363; <http://www.aiche.org/meeting/1997/annual>.

17-18 Midwest Univ. Industry Technology Transfer Conf., *Chicago, IL*. L.W. Sircy, Technology Transfer Conferences, Inc., 325 Plus Park Blvd., #108, Nashville, TN 37217; 615-366-0679; fax 615-366-0695.

17-19 ▼ 1997 Intl. Conf. on Tungsten, Refractory Metals, and Alloys: Processing, Properties, and Applications, *Orlando, FL*. B. Sun, Metal Powder Industries Federation, 105 College Rd. East, Princeton, NJ 08540-6692; 609-452-7700; fax 609-987-8523; e-mail info@mpif.org; <http://www.mpif.org>.

17-20 16th Intl. Congress on Applications of Lasers and Electro-Optics, *San Diego, CA*. D. Flynn, Conf. Coordinator, Laser Inst. of America, 12424 Research Pkwy., Ste. 125, Orlando, FL 32826; 407-380-1553; fax 407-380-5588.

DECEMBER 1997

1-5 MRS Fall Meeting, *Boston, MA*. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 412-779-3003; fax 412-779-8313; <http://www.mrs.org/> MRS.

9-10 ▼ 14th Annual Flat Information Displays Conf., *Monterey, CA*. L. Barretto, Stanford Resources, Inc., 3150 Almaden Expwy., Ste. 255, San Jose, CA 95118; 408-448-4440; fax 408-448-4445; e-mail stanford.resources@internetmci.com; <http://www.stanfordresources.com>

13-17 ▼ Intl. Conf. on Molecular Electronics—Science and Technology, *Humacao, PR*. Engineering Foundation, 345 E. 47th St., New York, NY 10017; 212-705-7836; fax 212-705-7441; e-mail engfnd@aol.com; <http://www.engfnd.org>.

16-20 9th Intl. Workshop on Physics of Semiconductor Devices, *Delhi, India*. S.K. Agarwal, Secretary, IWPSD-97, Solid State Physics Lab., Lucknow Rd., Timarpur, Delhi-110054, India; 91-11-238739; fax 91-11-2913609; e-mail ska@drsspl.ren.nic.in.

JANUARY 1998

6-9 7th Joint MMM-Intermag Magnetism Conf., *San Francisco, CA*. D. Suiters, Conf. Coordinator, 655 15th St. N.W., Ste. 300, Washington, DC 20005; 202-639-5088; fax 202-347-6109; e-mail magnetism@courtesy.assoc.com.

11-16 ▼ Surface Characterization of Adsorption and Interfacial Reactions II, *Kona, HI*. Engineering Foundation, 345 E. 47th St., New York, NY 10017; 212-705-7836; fax 212-705-7441; e-mail engfnd@aol.com; <http://www.engfnd.org>.

18-21 ▼ PCSI-25: 25th Conference on the Physics and Chemistry of Semiconductor Interfaces, *Salt Lake City, UT*. J.D. Dow, 6031 East Cholla Lane, Scottsdale, AZ 85253; fax 602-423-5183; e-mail feenstra@andrew.cmu.edu; <http://istm1.phys.cmu.edu/pcsi/>.

20-24 ▼ ACeRS Engineering Ceramics Division 22nd Conf. on Composites, Advanced Ceramics, Materials, and Structures, *Cocoa Beach, FL*. American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrvc@acers.org; <http://www.acers.org>.

FEBRUARY 1998

15-19 127th TMS Annual Meeting, *San Antonio, TX*. Customer Service Dept., TMS, 420 Commonwealth Dr., Warrendale, PA 15086; 412-776-9000; fax 412-776-3770; e-mail csc@tms.org; <http://www.tms.org/meetings/meeting.html>.

22-27 ▼ High-Temperature Electronic Materials, Devices and Sensors, *San Diego, CA*. Engineering Foundation, 345 E. 47th St., Ste. 303, New York, NY 10017-2375; 212-705-7836; fax 212-705-7441; e-mail engfnd@aol.com; <http://www.engfnd.org/>.

22-27 ▼ Microlithography Conf., *Santa Clara, CA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; <http://www.spie.org>.

23-26 SAE Intl. Congress, *Detroit, MI*. Meetings & Exhibits Dept., Society of Automotive Engineers, 400 Commonwealth Dr., Warrendale, PA 15096-0001; 412-776-4841; fax 412-776-1830; e-mail tim@sae.org.

MARCH 1998

1-4 ▼ 10th Intl. Symposium on Integrated Ferroelectrics, *Monterey, CA*. A. Miller, ISIF-98 Conf. Coordinator, Intl. Symposium on Integrated Ferroelectrics, Univ. of Colorado at Colorado Springs, P.O. Box 7150, Colorado Springs, CO 80933-7150; 719-262-3488; fax 719-594-4257; e-mail asmiller@vlsia.uccs.edu.

1-5 ▼ Smart Structures and Materials Conf., *San Diego, CA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; <http://www.spie.org>.

1-6 ▼ Pitcon® '98—A Kaleidoscope of Chemistry, *New Orleans, LA*. The Pittsburgh Conf., Dept. CFP, 300 Penn Center Blvd., Ste. 332, Pittsburgh, PA 15235-5503; 412-825-3220; fax 412-825-3224; e-mail pittconinfo@pittcon.org.

12-13 ▼ JFCC Intl. Workshop in Fine Ceramics '98—Ceramic Material Systems with Composite Structure, *Nagoya, Japan*. N. Kosuge, c/o JFCC, 2-4-1 Mutsuno, Atsuta, Nagoya 456, Japan; 81-52-871-3500; fax 81-52-871-3599.

16-20 ▼ Intl. Conf. on Porous Semiconductors—Science and Technology, *Mallorca, Spain*. V. Parkhutik, Dept. of Applied Thermodynamics, Technical Univ. of Valencia, Camino de Vera s/n, 46071 Valencia, Spain; 34-6-387-7328; fax 34-6-387-7329; e-mail psst-98@upvnet.upv.es; http://www.upv.es/psst_98.

18-20 ▼ 6th Intl. Symposium on Trends and Applications of Thin Films, *Regensburg, Germany*. H. Hoffmann, Inst. für Experimentelle und Angewandte Physik, Univ. Regensburg, Universitätsstrasse 31, D-93040 Regensburg, Germany; 49-941-943-2621; fax 49-941-943-4544; e-mail horst.hoffmann@physik.uni-regensburg.de.

23-27 9th Asia-Pacific Conf. on Nondestructive Testing, Spring Conf., and 7th Annual Research Symposium, *Anaheim, CA*. American Society for Nondestructive Testing, Inc., 1711 Arlingate Lane, P.O. Box 28518, Columbus, OH 43228-0518; 800-222-2768 or 614-274-6003; fax 614-274-6899; <http://www.asnt.org>.

29-3 ▼ Symposium on Applications of Spectroscopy to Superconducting Materials—215th Spring National American Chemical Society Meeting, *Dallas, TX*. E. Faulques, Inst. Matériaux, LPC, 2 rue de la Houssinière, BP 32229, F-44322 Nantes Cedex 3, France; 33-2-40-373972; fax 33-2-40-373991; e-mail faulques@cncs-irmn.fr; <http://www.acs.org>.

30-3 ▼ Nondestructive Evaluation of Aging Infrastructure and Manufacturing, *San Antonio, TX*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; <http://www.spie.org>.

APRIL 1998

13-17 MRS Spring Meeting, *San Francisco, CA*. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 412-779-3003; fax 412-779-8313; <http://www.mrs.org/> MRS.

20-25 7th Conf. on Frontiers of Electron Microscopy in Materials Science, *Irsee, Germany*. Kloster Irsee, Schwaebisches Tagungs- und Bildungszentrum, Klostering 4, 87660 Irsee, Germany; 49-8341-906-00; fax 49-8341-742-78.

26-1 44th Annual Technical Meeting of the Inst. of Environmental Sciences, *Phoenix, AZ*. Inst. of Environmental Sciences, 940 E. Northwest Hwy., Mt. Prospect, IL 60056; 847-255-1561; 847-255-1699; e-mail istenvsci@aol.com.

26-1 Nonstoichiometric Ceramics and Intermetallics, *Kona, HI*. Engineering Foundation, 345 E. 47th St., New York, NY 10017; 212-705-7836; fax 212-705-7441; e-mail engfnd@aol.com; <http://www.engfnd.org>.

27-1 ▼ The 25th International Conference on Metallurgical Coatings and Thin Films ICMCTF 98, *San Diego, CA*. Mary S. Gray, Suite 136, 14011-F Saint Germain Drive, Centerville, VA 20121; fax 703-968 8877; e-mail 104673.1235@compuserve.com.

28-30 ▼ Intl. Conf. on Magnesium Alloys and Their Applications, *Wolfsburg, Germany*. P. Geis, Conf. Secretariat, Deutsche Gesellschaft für Materialkunde e.V., Hamburger Allee 26, D-60486 Frankfurt, Germany; 49-69-7917-758; fax 49-69-7917-733.

MAY 1998

3-6 ▼ 100th ACeRS Annual Meeting, *Cincinnati, OH*. American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrvc@acers.org; <http://www.acers.org>.

17-22 ▼ Fluidization IX, *Tamarron, CO*. Engineering Foundation, 345 E. 47th St., New York, NY 10017; 212-705-7836; fax 212-705-7441; e-mail engfnd@aol.com; <http://www.engfnd.org>.

26-29 ▼ High Temperature Structural Silicides, *Cape Cod, MA*. Engineering Foundation, 345 E. 47th St., New York, NY 10017; 212-705-7836; fax 212-705-7441; e-mail engfnd@aol.com; <http://www.engfnd.org>.

JUNE 1998

1-5 6th Intl. Symposium on Acoustic Emission from Composite Materials, *San Antonio, TX*. American Society for Nondestructive Testing, Inc., 1711 Arlingate Lane, P.O. Box 28518, Columbus, OH 43228-0518; 800-222-2768 or 614-274-6003; fax 614-274-6899; <http://www.asnt.org>.

2-5 ▼ 3rd European Solid Oxide Fuel Cell Forum, *Nantes, France*. 3rd European SOFC Forum Secretariat, c/o EDF, Dept. CIMA, Attn. Ph. Stevens, Les Renardières, F-77818 Morét sur Loing, France; fax 33-1-60-73-67-21; e-mail Philippe.Stevens@der.edf.gdf.fr.

7-12 ▼ Modeling of Casting, Welding, and Advanced Solidification Processes VIII, *San Diego, CA*. Engineering Foundation, 345 E. 47th St., New York, NY 10017; 212-705-7836; fax 212-705-7441; e-mail engfnd@aol.com; <http://www.engfnd.org>.

8-10 ▼ 5th Intl. Conf. on Computer Aided Assessment and Control of Localized Damage, *Bologna, Italy*. L. Kerr, Localized Damage 98 Conf. Secretariat, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK; 44-1703-293223; fax 44-1703-292853; e-mail liz@wessex.ac.uk; <http://www.wessex.ac.uk>.

14-19 9th World Ceramics Congress and Forum on New Materials, *Florence, Italy*. CIMTEC '98, P.O. Box 174, 48018 Faenza, Italy; 39-546-663362; fax 39-546-664138; <http://www.dinamica.it/cimtec>.

14-19 ▼ Small Fatigue Cracks: Mechanics and Mechanisms, *Snowbird, UT*. Engineering Foundation, 345 E. 47th St., New York, NY 10017; 212-705-7836; fax 212-705-7441; e-mail engfnd@aol.com; <http://www.engfnd.org>.

22-26 ▼ 12th Intl. Conf. on Ion Implantation Technology, *Kyoto, Japan*. I. Yamada, Ion Beam Engineering Experimental Lab, Kyoto Univ., Sakyo, Kyoto 606-01, Japan; 81-75-753-5951; fax 81-75-751-6774; e-mail iit98@nishiki.kuee.kyoto-u.ac.jp; <http://nishiki.kuee.kyoto-u.ac.jp/iit98>.

28-2 ▼ 3rd Oxford Conf. on Spectrometry, *Egham, Surrey, UK*. A. Springsteen, 3rd Oxford Conf., c/o Labsphere, Inc., P.O. Box 70, Shaker St., North Sutton, NH 03260; 603-927-4266; fax 603-927-4694; e-mail art_spring@labsphere.com.

29-3 ▼ 3rd Intl. Conf. on Electric Charge in Solid Insulators, *Tours, France*. Société Française du Vide, Div. Diélectriques, 19 rue du Renard, 75004 Paris, France; 33-1-53-01-90-30; fax 33-1-42-78-63-20; e-mail sfv@club-internet.fr.

JULY 1998

5-10 Advances in Cement and Concrete, *Banff, Alberta, Canada*. Engineering Foundation, 345 E. 47th St., New York, NY 10017; 212-705-7836; fax 212-705-7441; e-mail engfnd@aol.com; <http://www.engfnd.org>.

5-10 ▼ Intl. Congress on Glass '98, *San Francisco, CA*. American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersvc@acers.org; <http://www.acers.org>.

7-9 Micro 98, Hammersmith, *London, UK*. Royal Microscopical Society, 37/38 St. Clements, Oxford OX4 1AJ, UK; 44-1-865-248768; 44-1-865-791237; e-mail meetings@rms.org.uk; <http://www.rms.org.uk>.

12-16 3rd Pacific Rim Intl. Conf. on Advanced Materials and Processing, *Honolulu, HI*. P. Weiss, PRICM 3 Program Coordinator, TMS, 420 Commonwealth Dr., Warrendale, PA 15086-7514; 412-776-9000, ext. 227; fax 412-776-3770; e-mail weissp@tms.org.

19-24 ▼ SPIE Annual Meeting and Optical Instrumentation Show, *San Diego, CA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; <http://www.spie.org>.

AUGUST 1998

23-26 ▼ Ceramic Manufacturing Council's Manufacturing Workshops, *Lexington, KY*. American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersvc@acers.org; <http://www.acers.org>.

24-27 Electroceramics VI, 11th Intl. Symposium on Applications of Ferroelectrics, and 4th European Conf. on Applications of Polar Dielectrics, *Montreux, Switzerland*. ECAPD & ISAF, Electroceramics VI, LC-DMX-EPFL, CH-1015 Lausanne, Switzerland; e-mail electro@lc.dmx.epfl.ch; <http://dmxwww.epfl.ch/lc/electro/home.html>.

26-31 12th Intl. Conf. on Crystal Growth, *Jerusalem, Israel*. ICCG 12, c/o Intl. Travel & Congresses Ltd., P.O. Box 29313, Tel Aviv 61292, Israel; 972-3-5102538; fax 972-3-5160604.

30-3 ▼ 15th Intl. Workshop on Rare-Earth Magnets and Their Applications, *Dresden, Germany*. Deutsche Gesellschaft für Materialkunde e.V., Hamburger Allee 26, D-60486 Frankfurt, Germany; 49-69-7917-758; fax 49-69-7917-733.

31-4 ▼ 11th Intl. Conf. on Ion Beam Modification of Materials, *Amsterdam, The Netherlands*. A. Polman, Chairman, 31-20-6081234; fax 31-20-6684106; e-mail ibmm98@amolf.nl; <http://www.amolf.nl/ibmm98>.

SEPTEMBER 1998

4 ▼ 10th Intl. Symposium on Magnetic Anisotropy and Coercivity in Rare-Earth Transition Metal Alloys, *Dresden, Germany*. Deutsche Gesellschaft für Materialkunde e.V., Hamburger Allee 26, D-60486 Frankfurt, Germany; 49-69-7917-758; fax 49-69-7917-733.

13-17 ▼ Europhysics Conf. on Macromolecular Physics: Electro-Optical Properties of Polymers and Related Phenomena, *Varenna, Lake of Como, Italy*. A. Bolognesi, Istituto di Chimica delle Macromolecole, Via E. Bassini 15, 20133 Milano, Italy; 39-2-236-9373; fax 39-2-236-2946; e-mail lb@icm.mi.cnr.it.

13-18 Applied Superconductivity Conf., *Palm Desert, CA*. Centennial Conferences, 303-499-2299; fax 303-499-2599; e-mail centennial@orci.com.

15-19 4th Intl. Conf. on Computer Simulation of Radiation Effects in Solids, *Okayama, Japan*. Y. Yamamura, Okayama Univ. of Science, Ridai-cho, Okayama 700, Japan; 81-86-252-3161; fax 81-86-255-7700; e-mail yama@dap11.ous.ac.jp.

OCTOBER 1998

18-22 ▼ Powder Metallurgy World Congress, *Granada, Spain*. PM98 Secretariat, European Powder Metallurgy Assoc., Old Bank Bldgs., Bellstone, Shrewsbury SY1 1HU, UK; 44-1743-248899; fax 44-1743-362968; e-mail pm98@epma.com; <http://www.epma.com>.

19-23 Fall Conf. and Quality Testing Show, *Nashville, TN*. American Society for Nondestructive Testing, Inc., 1711 Arlingate Lane, P.O. Box 28518, Columbus, OH 43228-0518; 800-222-2768 or 614-274-6003; fax 614-274-6899; <http://www.asnt.org>.

25-30 Intl. Rare Earths Conf., *Fremantle, Western Australia*. Secretariat, Materials Inst. of Western Australia, 133 Salgado Rd., Wembley, Western Australia 6014; 61-9-387-9590; fax 61-9-383-9639; e-mail RE98@miwa.org.au; <http://www.miwa.org.au/IREC98>.

26-29 5th Intl. Symposium on Functionally Graded Materials, *Dresden, Germany*. FGM 09 Secretariat, Conf. Svc., TU Dresden GmbH, Lufthansa City Ctr., Frau Deckert/Frau Wolf, Georg Baehr Strasse 8, 01069 Dresden, Germany; or K.J. Bowman, Purdue 765-494-4096.

30-4 MRS Fall Meeting, *Boston, MA*. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 412-779-3003; fax 412-779-8313; <http://www.mrs.org/> MRS.

NOVEMBER 1998

1-6 ▼ Photonics East and Electronic Imaging Intl. Exhibition, *Boston, MA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; <http://www.spie.org>.

DECEMBER 1998

8-11 2nd Asian Meeting on Ferroelectrics, Intl., *Singapore*. AMF-2 Secretariat, CCE, Nanyang Tech. Univ., Singapore 639798; 65-799-4723; fax 65-793-0997; e-mail amf2@ntu.edu.sg.

FEBRUARY 1999

6-12 ▼ Photonics West, *San Jose, CA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; <http://www.spie.org>.

MARCH 1999

14-19 ▼ Microlithography Conf., *Santa Clara, CA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; <http://www.spie.org>.

14-19 ▼ Smart Structures and Materials Conf., *San Diego, CA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; <http://www.spie.org>.

APRIL 1999

5-9 ▼ MRS Spring Meeting, *San Francisco, CA*. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 412-779-3003; fax 412-779-8313; <http://www.mrs.org/> MRS.

JULY 1999

18-23 ▼ SPIE Annual Meeting and Optical Instrumentation Show, *Denver, CO*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; <http://www.spie.org>.

26-30 ▼ 6th Intl. Conf. on the Structure of Surfaces, *Vancouver, Canada*. K.A.R. Mitchell, Dept. of Chemistry, Univ. of British Columbia, Vancouver, BC, Canada V6T 1Z1; 604-822-3266; fax 604-822-2847.

AUGUST 1999

23-27 ▼ 10th Intl. Conf. on Rapidly Quenched and Metastable Materials, *Bangalore, India*. S. Ranganathan, Dept. of Metallurgy, Indian Inst. of Science, Bangalore 560012, India; 91-80-309-2678; fax 91-80-331-2991; e-mail rq10@metallurg.iisc.ernet.in; <http://www.metallurg.iisc.ernet.in/~rqten>.

OCTOBER 1999

4-8 ▼ 8th European Conf. on Applications of Surface and Interface Analysis, *Sevilla, Spain*. ECASIA99, Dept. Física Aplicada, C-XII, Facultad de Ciencias, Univ. Autónoma de Madrid, Cantoblanco E 28049, Madrid, Spain; fax 34-1-397-3969; e-mail josem.sanz@uam.es; <http://www.uam.es/fa/ecasia99.html>. □